TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (DTMOS II)

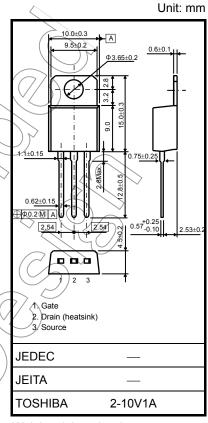
TK15D60U

Switching Regulator Applications

- Low drain-source ON-resistance: RDS (ON) = 0.24Ω (typ.)
- High forward transfer admittance: $|Y_{fs}| = 8.5 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = 100 \mu A (max) (V_{DS} = 600 V)$
- Enhancement mode: $V_{th} = 3.0 \text{ to } 5.0 \text{ V (V}_{DS} = 10 \text{ V, I}_{D} = 1 \text{ mA})$

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain-source voltage		V_{DSS}	600	(y)
Gate-source voltage		V _{GSS}	±30	(\vee)
Drain current	DC (Note 1)	I _D	15	
	Pulse (Note 1)	I _{DP}	30	\
Drain power dissipation (Tc = 25°C)		P_{D}	170	∨ w
Single pulse avalanche energy (Note 2)		E _{AS}	81	mJ
Avalanche current		I _{AR}	15	A
Repetitive avalanche energy (Note 3)		EAR	17	mJ
Channel temperature		T _{ch})) 150	°C
Storage temperature range		Tetg	–55 to 150	√ °C



Weight: 1.35 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

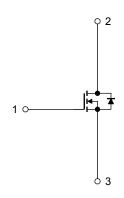
Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	Rth (ch-c)	0.735	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	83.3	°C/W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: V_{DD} = 90 V, T_{ch} = 25°C (initial), L = 0.63 mH, R_G = 25 Ω , I_{AR} = 15 A

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.



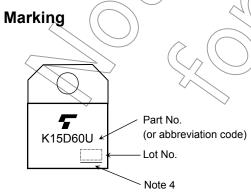
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I _{GSS}	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$	_	_	±1	μΑ
Drain cut-off curre	ent	I _{DSS}	V _{DS} = 600 V, V _{GS} = 0 V	_	_	100	μΑ
Drain-source brea	akdown voltage	V (BR) DSS	I _D = 10 mA, V _{GS} = 0 V	600	_		V
Gate threshold vo	oltage	V _{th}	V _{DS} = 10 V, I _D = 1 mA	3.0	_	5.0	V
Drain-source ON	-resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 7.5 A	()	0.24	0.3	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 7.5 A	2.1	8.5		S
Input capacitance	•	C _{iss}		())	950	_	
Reverse transfer capacitance		C _{rss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	47	_	pF
Output capacitance		C _{oss}		_	2300	_	
Switching time	Rise time	t _r	10 V ID = 7.5 A VOUT	_	37	//	
	Turn-ON time	t _{on}	0 V		80	> —	ns
	Fall time	t _f	V _{DD} ≈ 300 V		8		113
	Turn-OFF time	t _{off}	Duty $\leq 1\%$, $t_W = 10 \mu s$		105	_	
Total gate charge Q _g		Qg			17		
Gate-source char	ge	Q _{gs}	$V_{DD} \approx 400 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 15 \text{ A}$) —	10		nC
Gate-drain charge Q _{gd}				7	_		

Source-Drain Ratings and Characteristics (Ta = 25°C)

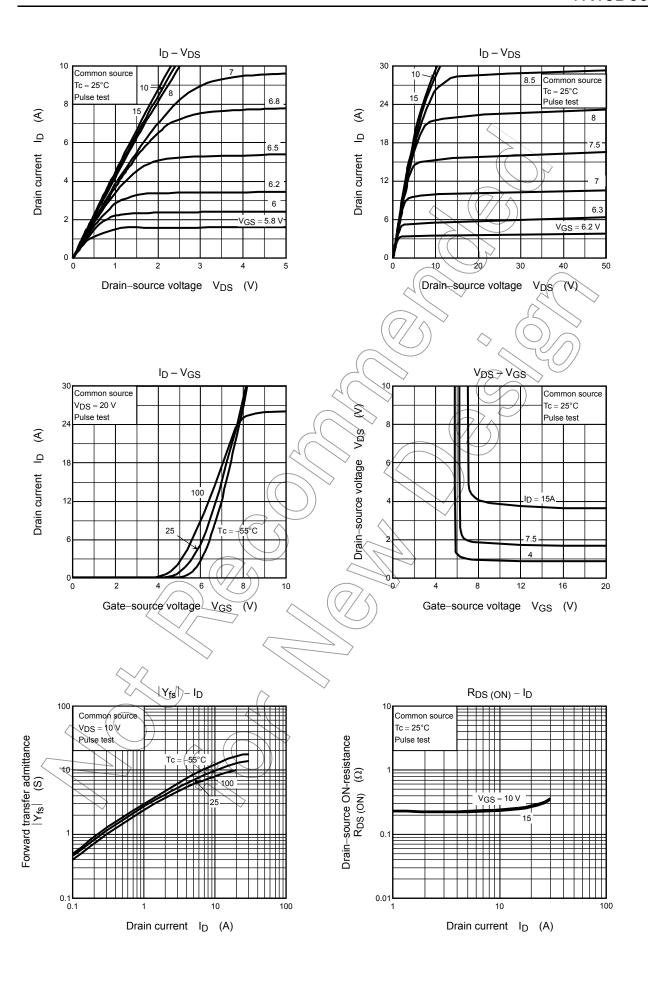
Characteristics	Symbol	Test-Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}		_	_	15	Α
Pulse drain reverse current (Note 1)	I _{DRP}		_	_	30	Α
Forward voltage (diode)	VDSF	$I_{DR} = 15 \text{ A}, V_{GS} = 0 \text{ V}$	_	_	-1.7	V
Reverse recovery time	tir	$I_{DR} = 15 \text{ A}, V_{GS} = 0 \text{ V},$	_	530	_	ns
Reverse recovery charge	Q _{rr}	dl _{DR} /dt = 100 A/μs	_	9.0	_	μС

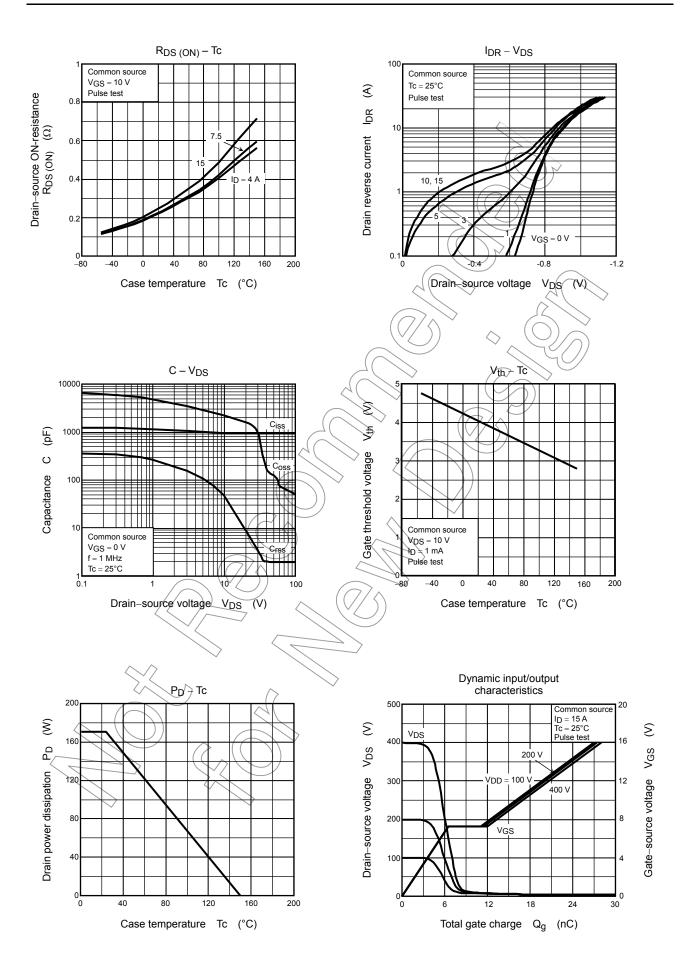
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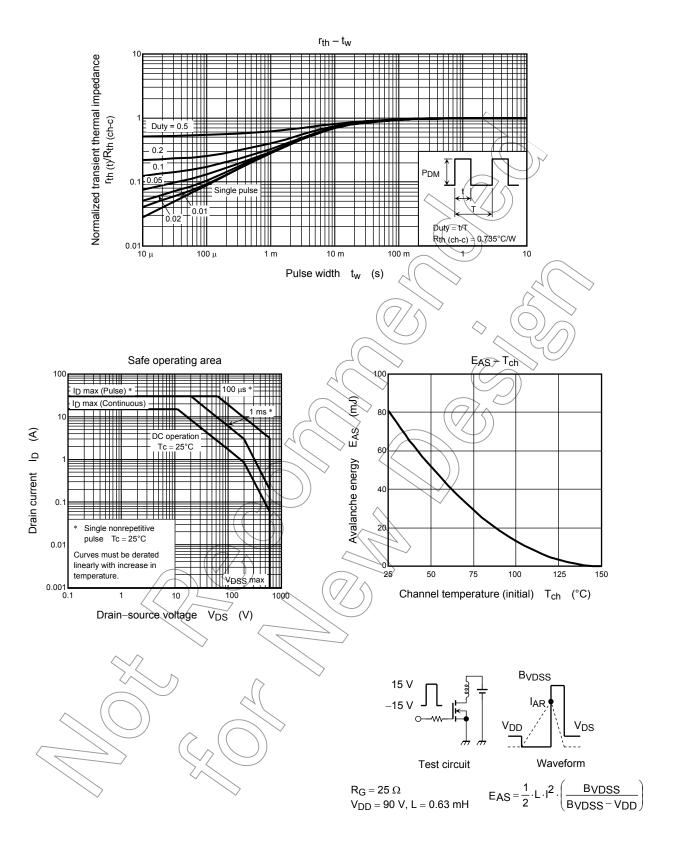
Note 4 : A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.





4



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6